Microchip Technology - PIC32MM0032GPL020T-I/SS Datasheet

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

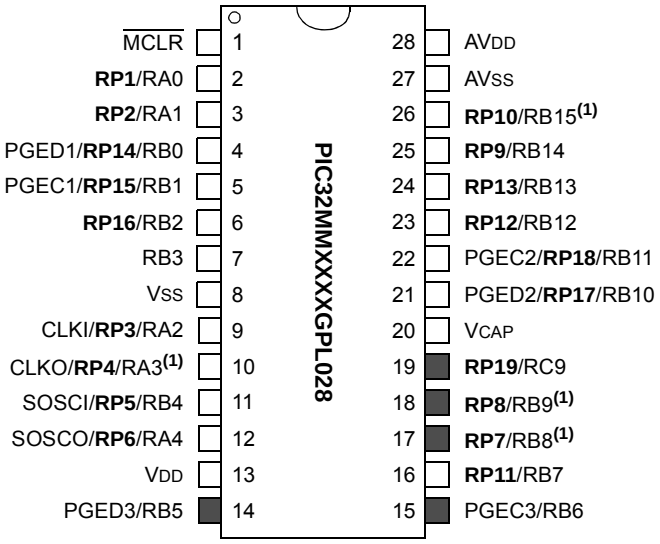
"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	MIPS32® microAptiv™
Core Size	32-Bit Single-Core
Speed	25MHz
Connectivity	IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, I²S, POR, PWM, WDT
Number of I/O	16
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 11x10/12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mm0032gpl020t-i-ss

Pin Diagrams (Continued)

28-Pin SPDIP(2)/SSOP/SOIC



Legend: Shaded pins are up to 5V tolerant.

Note 1: Pin has an increased current drive strength. Refer to **Section 26.0 "Electrical Characteristics"** for details.

2: Only PIC32MM0064GPL028 comes in a 28-pin SPDIP package.

TABLE 4: COMPLETE PIN FUNCTION DESCRIPTIONS FOR 28-PIN SPDIP/SSOP/SOIC DEVICES

Pin	Function	Pin	Function
1	MCLR	15	PGEC3/RB6
2	VREF+/AN0/**RP1**/OCM1E/INT3/RA0	16	**RP11**/RB7
3	VREF-/AN1/**RP2**/OCM1F/RA1	17	TCK/**RP7**/U1CTS/SCK1/OCM1A/RB8(1)
4	PGED1/AN2/C1IND/C2INB/**RP14**/RB0	18	TMS/REFCLKI/**RP8**/T1CK/T1G/U1RTS/U1BCLK/SDO1/C2OUT/OCM1B/INT2/RB9(1)
5	PGEC1/AN3/C1INC/C2INA/**RP15**/RB1	19	**RP19**/RC9
6	AN4/C1INB/**RP16**/RB2	20	VCAP
7	AN11/C1INA/RB3	21	PGED2/TDO/**RP17**/RB10
8	VSS	22	PGEC2/TDI/**RP18**/RB11
9	OSC1/CLKI/AN5/**RP3**/OCM1C/RA2	23	AN7/LVDIN/**RP12**/RB12
10	OSC2/CLKO/AN6/**RP4**/OCM1D/RA3(1)	24	AN8/**RP13**/RB13
11	SOSCI/**RP5**/RB4	25	CDAC1/AN9/**RP9**/RTCC/U1TX/SDI1/C1OUT/INT1/RB14
12	SOSCO/SCLKI/**RP6**/PWRLCLK/RA4	26	AN10/REFCLKO/**RP10**/U1RX/SS1/FSYNC1/INT0/RB15(1)
13	VDD	27	AVSS
14	PGED3/RB5	28	AVDD

Note 1: Pin has an increased current drive strength.

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com**. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000000A is version A of document DS30000000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; **http://www.microchip.com**
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at **www.microchip.com** to receive the most current information on all of our products.

Referenced Sources

This device data sheet is based on the following individual sections of the *"PIC32 Family Reference Manual"*. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note: To access the documents listed below, browse the documentation section of the Microchip web site (www.microchip.com).

- **Section 1. "Introduction"** (DS60001127)
- **Section 5. "Flash Programming"** (DS60001121)
- **Section 7. "Resets"** (DS60001118)
- **Section 8. "Interrupts"** (DS60001108)
- **Section 10. "Power-Saving Modes"** (DS60001130)
- **Section 14. "Timers"** (DS60001105)
- **Section 19. "Comparator"** (DS60001110)
- **Section 21. "UART"** (DS61107)
- **Section 23. "Serial Peripheral Interface (SPI)"** (DS61106)
- **Section 25. "12-Bit Analog-to-Digital Converter (ADC) with Threshold Detect"** (DS60001359)
- **Section 28. "RTCC with Timestamp"** (DS60001362)
- **Section 30. "Capture/Compare/PWM/Timer (MCCP and SCCP)"** (DS60001381)
- **Section 33. "Programming and Diagnostics"** (DS61129)
- **Section 36. "Configurable Logic Cell"** (DS60001363)
- **Section 45. "Control Digital-to-Analog Converter (CDAC)"** (DS60001327)
- **Section 50. "CPU for Devices with MIPS32® microAptiv™ and M-Class Cores"** (DS60001192)
- **Section 59. "Oscillators with DCO"** (DS60001329)
- **Section 60. "32-Bit Programmable Cyclic Redundancy Check (CRC)"** (DS60001336)
- **Section 62. "Dual Watchdog Timer"** (DS60001365)

1.0 DEVICE OVERVIEW

Note: This data sheet summarizes the features of the PIC32MM0064GPL036 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32). The information in this data sheet supersedes the information in the FRM.

This data sheet contains device-specific information for the PIC32MM0064GPL036 family devices.

Figure 1-1 illustrates a general block diagram of the core and peripheral modules in the PIC32MM0064GPL036 family of devices.

Table 1-1 lists the pinout I/O descriptions for the pins shown in the device pin tables.

FIGURE 1-1: PIC32MM0064GPL036 FAMILY BLOCK DIAGRAM

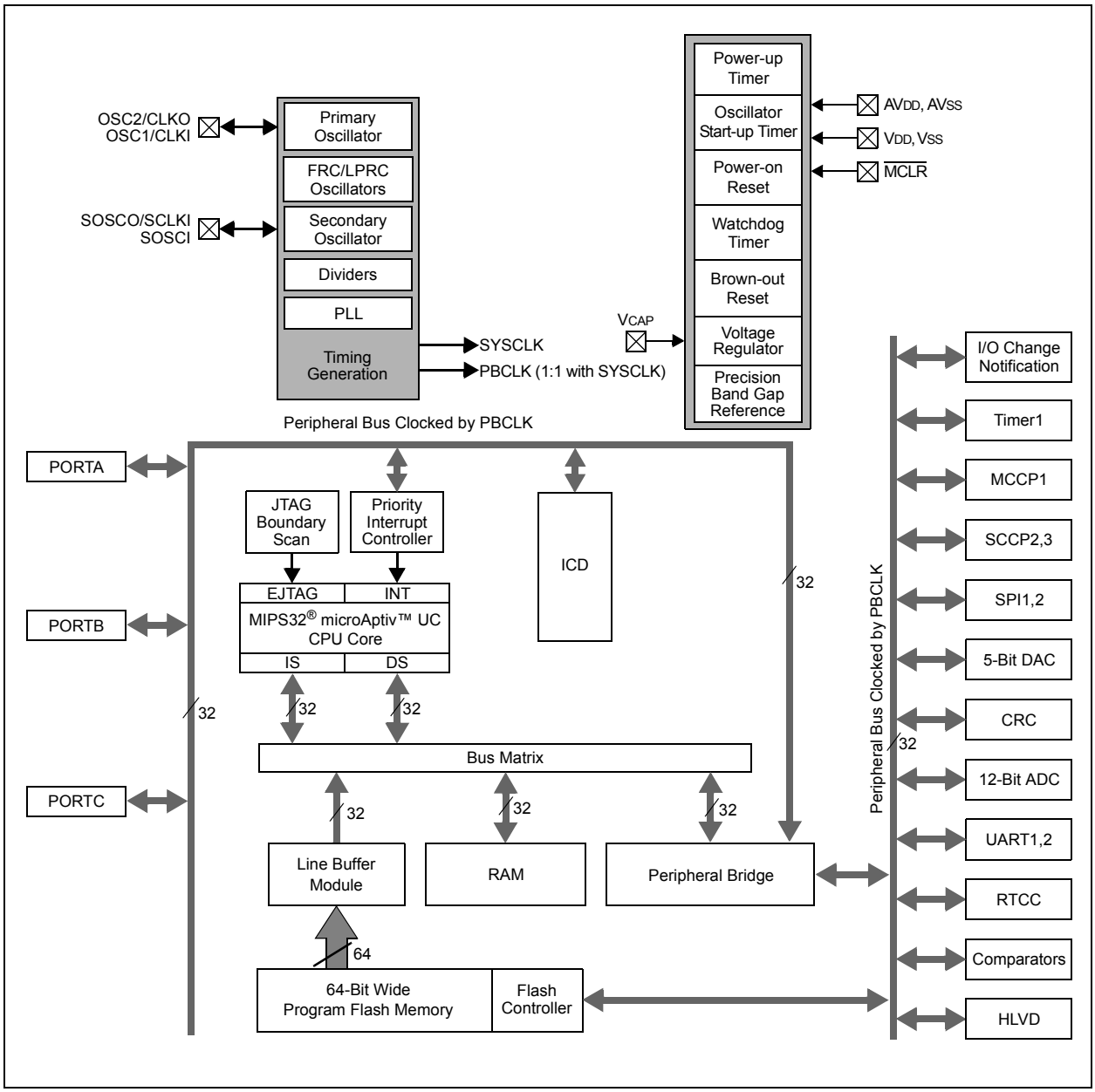
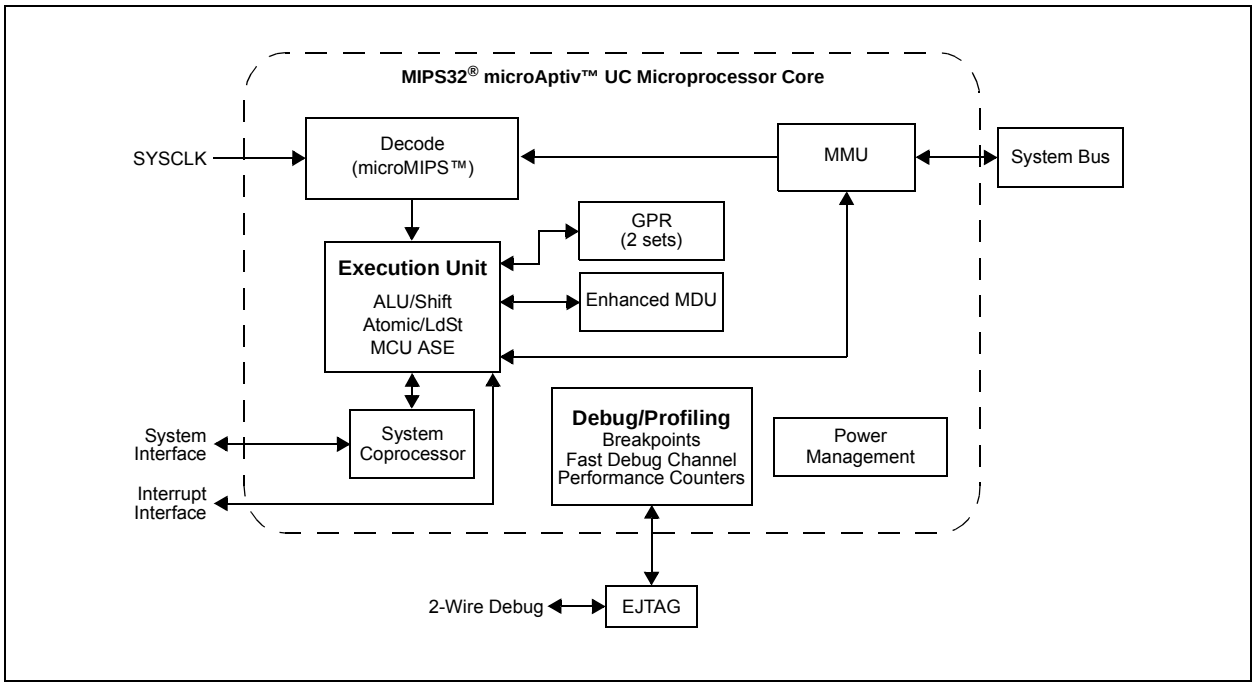


FIGURE 3-1: PIC32MM0064GPL036 FAMILY MICROPROCESSOR CORE BLOCK DIAGRAM



REGISTER 5-7: NVMBWP: NVM BOOT FLASH (PAGE) WRITE-PROTECT REGISTER(1)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-1	U-0	U-0	U-0	U-0	R/W-1	R/W-1	R/W-1
	BWPULOCK	—	—	—	—	BWP2(2)	BWP1(2)	BWP0(2)
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **BWPULOCK:** Boot Alias Write-Protect Unlock bit
1 = BWPx bits are not locked and can be modified
0 = BWPx bits are locked and cannot be modified
This bit is only clearable and cannot be set except by any Reset.

bit 14-11 **Unimplemented:** Read as '0'

bit 10 **BWP2:** Boot Alias Page 2 Write-Protect bit(2)
1 = Write protection for physical address, 0x1FC00000 through 0x1FC007FF, is enabled
0 = Write protection for physical address, 0x1FC00000 through 0x1FC007FF, is disabled

bit 9 **BWP1:** Boot Alias Page 1 Write-Protect bit(2)
1 = Write protection for physical address, 0x1FC00800 through 0x1FC00FFF, is enabled
0 = Write protection for physical address, 0x1FC00800 through 0x1FC00FFF, is disabled

bit 8 **BWP0:** Boot Alias Page 0 Write-Protect bit(2)
1 = Write protection for physical address, 0x1FC01000 through 0x1FC017FF, is enabled
0 = Write protection for physical address, 0x1FC01000 through 0x1FC017FF, is disabled

bit 7-0 **Unimplemented:** Read as '0'

Note 1: Writes to this register require an NVMKEY unlock sequence. Refer to **Section 5.1 "Flash Controller Registers Write Protection"** for details.

2: These bits can be modified only when the associated unlock bit (BWPULOCK) is set.

7.1 CPU Exceptions

CPU Coprocessor 0 contains the logic for identifying and managing exceptions. Exceptions can be caused by a variety of sources, including boundary cases in data, external events or program errors. Table 7-1 lists the exception types in order of priority.

TABLE 7-1: MIPS32® microAptiv™ UC MICROPROCESSOR CORE EXCEPTION TYPES

Exception Type (In Order of Priority)	Description	Branches to	Status Bits Set	Debug Bits Set	EXCCODE	XC32 Function Name
Highest Priority						
Reset	Assertion of $\overline{\text{MCLR}}$.	0xBFC0_0000	BEV, ERL	—	—	_on_reset
Soft Reset	Execution of a RESET instruction.	0xBFC0_0000	BEV, SR, ERL	—	—	_on_reset
DSS	EJTAG debug single step.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DSS	—	—
DINT	EJTAG debug interrupt. Caused by setting the EjtagBrk bit in the ECR register.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DINT	—	—
NMI	Non-maskable interrupt.	0xBFC0_0000	BEV, NMI, ERL	—	—	_nmi_handler
Interrupt	Assertion of unmasked hardware or software interrupt signal.	See Table 7-2	IPL<2:0>	—	Int (0x00)	See Table 7-2
DIB	EJTAG debug hardware instruction break matched.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DIB	—	—
AdEL	Load address alignment error.	EBASE + 0x180	EXL	—	ADEL (0x04)	_general_exception_handler
IBE	Instruction fetch bus error.	EBASE + 0x180	EXL	—	IBE (0x06)	_general_exception_handler
DBp	EJTAG breakpoint (execution of SDBBP instruction).	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	DBp	—	—	—
Sys	Execution of SYSCALL instruction.	EBASE + 0x180	EXL	—	Sys (0x08)	_general_exception_handler
Bp	Execution of BREAK instruction.	EBASE + 0x180	EXL	—	Bp (0x09)	_general_exception_handler

TABLE 7-3: INTERRUPT REGISTER MAP

Virtual Address (BF80_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
F000	INTCON	31:16	—	—	—	—	—	—	—	—	—	VS<6:0>							0000
		15:0	—	—	—	MVEC	—	TPC<2:0>			—	—	—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP	0000
F010	PRISS	31:16	PRI7SS<3:0>				PRI6SS<3:0>				PRI5SS<3:0>				PRI4SS<3:0>				0000
		15:0	PRI3SS<3:0>				PRI2SS<3:0>				PRI1SS<3:0>				—	—	—	SS0	0000
F020	INTSTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	SRIPL<2:0>			SIRQ<7:0>								0000
F030	IPTMR	31:16	IPTMR<31:0>																0000
		15:0																	0000
F040	IFS0	31:16	CCP2IF	CCT1IF	CCP1IF	—	—	—	U1EIF	U1TXIF	U1RXIF	SPI1RXIF	SPI1TXIF	SPI1EIF	CLC2IF	CLC1IF	LVDIF	CRCIF	0000
		15:0	AD1IF	RTCCIF	CMP2IF	CMP1IF	T1IF	CNCIF(2)	CNBIF	CNAIF	INT4IF	INT3IF	INT2IF	INT1IF	INT0IF	CS1IF	CS0IF	CTIF	0000
F050	IFS1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CPCIF	NVMIF	—	—	—	U2EIF	U2TXIF	U2RXIF	SPI2RXIF	SPI2TXIF	SPI2EIF	—	—	CCT3IF	CCP3IF	CCT2IF	0000
F0C0	IEC0	31:16	CCP2IE	CCT1IE	CCP1IE	—	—	—	U1EIE	U1TXIE	U1RXIE	SPI1RXIE	SPI1TXIE	SPI1EIE	CLC2IE	CLC1IE	LVDIE	CRCIE	0000
		15:0	AD1IE	RTCCIE	CMP2IE	CMP1IE	T1IE	CNCIE(2)	CNBIE	CNAIE	INT4IE	INT3IE	INT2IE	INT1IE	INT0IE	CS1IE	CS0IE	CTIE	0000
F0D0	IEC1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CPCIE	NVMIE	—	—	—	U2EIE	U2TXIE	U2RXIE	SPI2RXIE	SPI2TXIE	SPI2EIE	—	—	CCT3IE	CCP3IE	CCT2IE	0000
F140	IPC0	31:16	—	—	—	INT0IP<2:0>			INT0IS<1:0>		—	—	—	CS1IP<2:0>			CS1IS<1:0>		0000
		15:0	—	—	—	CS0IP<2:0>			CS0IS<1:0>		—	—	—	CTIP<2:0>			CTIS<1:0>		0000
F150	IPC1	31:16	—	—	—	INT4IP<2:0>			INT4IS<1:0>		—	—	—	INT3IP<2:0>			INT3IS<1:0>		0000
		15:0	—	—	—	INT2IP<2:0>			INT2IS<1:0>		—	—	—	INT1IP<2:0>			INT1IS<1:0>		0000
F160	IPC2	31:16	—	—	—	T1IP<2:0>			T1IS<1:0>		—	—	—	CNCIP<2:0>(2)			CNCIS<1:0>(2)		0000
		15:0	—	—	—	CNBIP<2:0>			CNBIS<1:0>		—	—	—	CNAIP<2:0>			CNAIS<1:0>		0000
F170	IPC3	31:16	—	—	—	AD1IP<2:0>			AD1IS<1:0>		—	—	—	RTCCIP<2:0>			RTCCIS<1:0>		0000
		15:0	—	—	—	CMP2IP<2:0>			CMP2IS<1:0>		—	—	—	CMP1IP<2:0>			CMP1IS<1:0>		0000
F180	IPC4	31:16	—	—	—	CLC2IP<2:0>			CLC2IS<1:0>		—	—	—	CLC1IP<2:0>			CLC1IS<1:0>		0000
		15:0	—	—	—	LVDIP<2:0>			LVDIS<1:0>		—	—	—	CRCIP<2:0>			CRCIS<1:0>		0000
F190	IPC5	31:16	—	—	—	U1RXIP<2:0>			U1RXIS<1:0>		—	—	—	SPI1RXIP<2:0>			SPI1RXIS<1:0>		0000
		15:0	—	—	—	SPI1TXIP<2:0>			SPI1TXIS<1:0>		—	—	—	SPI1EIP<2:0>			SPI1EIS<1:0>		0000
F1A0	IPC6	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	U1EIP<2:0>			U1EIS<1:0>		—	—	—	U1TXIP<2:0>			U1TXIS<1:0>		0000
F1B0	IPC7	31:16				CCP2IP<2:0>			CCP2IS<1:0>		—	—	—	CCT1IP<2:0>			CCT1IS<1:0>		0000
		15:0	—	—	—	CCP1IP<2:0>			CCP1IS<1:0>		—	—	—	—	—	—	—	—	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively.

2: These bits are not available on 20-pin devices.

REGISTER 12-4: CCPxSTAT: CAPTURE/COMPARE/PWMx STATUS REGISTER (CONTINUED)

bit 3 **SCEVT:** Single Edge Compare Event Status bit
1 = A single edge compare event has occurred
0 = A single edge compare event has not occurred

bit 2 **ICDIS:** Input Capture Disable bit
1 = Event on input capture pin does not generate a capture event
0 = Event on input capture pin will generate a capture event

bit 1 **ICOV:** Input Capture Buffer Overflow Status bit
1 = The input capture FIFO buffer has overflowed
0 = The input capture FIFO buffer has not overflowed

bit 0 **ICBNE:** Input Capture Buffer Status bit
1 = The input capture buffer has data available
0 = The input capture buffer is empty

Note 1: This is not a physical bit location and will always read as '0'. A write of '1' will initiate the hardware event.

14.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note: This data sheet summarizes the features of the PIC32MM0064GPL036 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 21. "UART"** (DS61107) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32). The information in this data sheet supersedes the information in the FRM.

The UART module is one of the serial I/O modules available in the PIC32MM0064GPL036 family devices. The UART is a full-duplex, asynchronous communication channel that communicates with peripheral devices and personal computers through protocols, such as RS-232, RS-485, LIN/J2602 and IrDA®. The module also supports the hardware flow control option with the $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins, and also includes an IrDA encoder and decoder.

The primary features of the UART module are:

- Full-Duplex, 8-Bit or 9-Bit Data Transmission
- Even, Odd or No Parity Options (for 8-bit data)
- One or Two Stop Bits
- Hardware Auto-Baud Feature
- Hardware Flow Control Option
- Fully Integrated Baud Rate Generator (BRG) with 16-Bit Prescaler
- Baud Rates Ranging from 47.7 bps to 6.26 Mbps at 25 MHz
- 8-Level Deep First-In-First-Out (FIFO) Transmit Data Buffer
- 8-Level Deep FIFO Receive Data Buffer
- Parity, Framing and Buffer Overrun Error Detection
- Support for Interrupt Only on Address Detect (9th bit = 1)
- Separate Transmit and Receive Interrupts
- Loopback mode for Diagnostic Support
- LIN/J2602 Protocol Support
- IrDA Encoder and Decoder with 16x Baud Clock Output for External IrDA Encoder/Decoder Support
- Supports Separate UART Baud Clock Input
- Ability to Continue to Run when a Receive Overflow (ROV) Condition Exists
- Ability to Run and Receive Data during Sleep mode

Figure 14-1 illustrates a simplified block diagram of the UART module.

FIGURE 14-1: UARTx SIMPLIFIED BLOCK DIAGRAM

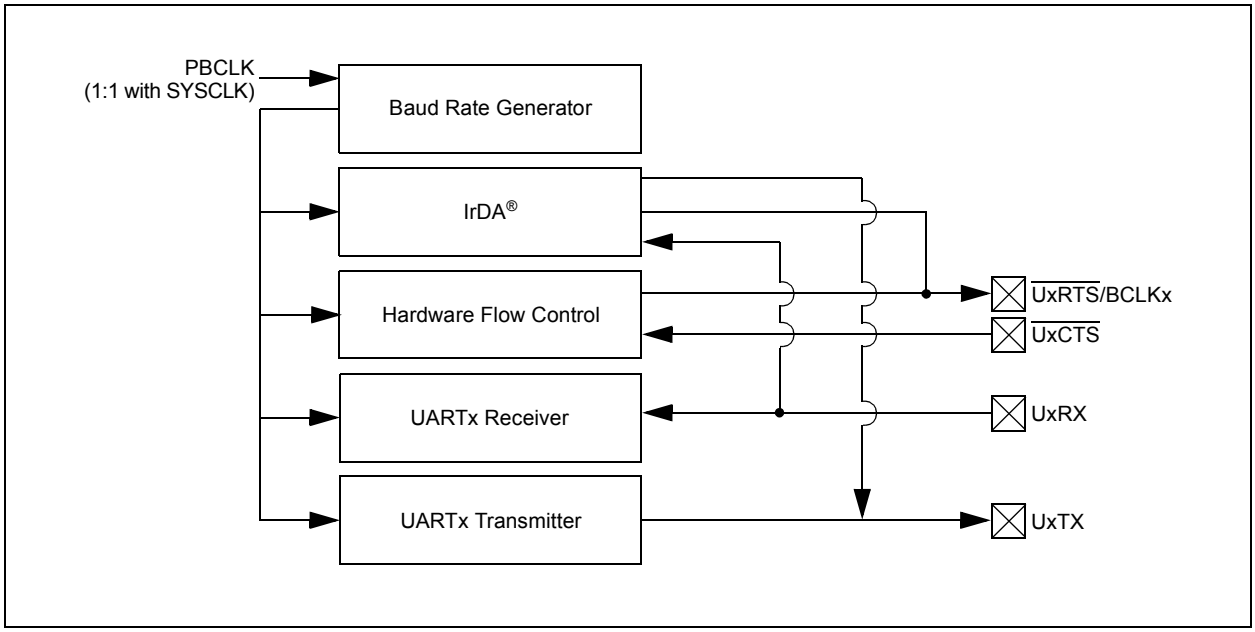


TABLE 16-1: ADC REGISTER MAP (CONTINUED)

Virtual Address (BF80_#)	Register Name(3)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
07E0	ADC1BUF14	31:16	ADC1BUF14<31:0>																0000
		15:0																	0000
07F0	ADC1BUF15	31:16	ADC1BUF15<31:0>																0000
		15:0																	0000
0800	AD1CON1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON		SIDL	—	—	FORM<2:0>			SSRC<3:0>				MODE12	ASAM	SAMP	DONE	0000
0810	AD1CON2	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	VCFG<2:0>			OFFCAL	BUFREGEN	CSCNA	—	—	BUFS	—	SMPI<3:0>				BUFM	—	0000
0820	AD1CON3	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ADRC	EXTSAM	—	SAMC<4:0>					ADCS<7:0>								0000
0840	AD1CHS	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	CH0NA<2:0>			CH0SA<4:0>					0000
0850	AD1CSS	31:16	—	CSS<30:28>			—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CSS<13:0>(1,2)														0000
0870	AD1CON5	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ASEN	LPEN	—	BGREQ	—	—	ASINT<1:0>		—	—	—	—	WM<1:0>		CM<1:0>		0000
0880	AD1CHIT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	CHH<13:0>(1,2)														0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: The CSS<13:11> and CHH<13:11> bits are not implemented in 20-pin devices.

2: The CSS<13:12> and CHH<13:12> bits are not implemented in 28-pin devices.

3: All registers in this table have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively.

REGISTER 16-1: AD1CON1: ADC CONTROL REGISTER 1

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	ON	—	SIDL	—	—	FORM<2:0>		
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0, HSC	R/W-0, HSC
	SSRC<3:0>				MODE12	ASAM	SAMP(1)	DONE(2)

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **ON:** ADC Operating Mode bit
1 = ADC module is operating
0 = ADC is off

bit 14 **Unimplemented:** Read as '0'

bit 13 **SIDL:** ADC Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-11 **Unimplemented:** Read as '0'

bit 10-8 **FORM<2:0>:** Data Output Format bits
For 12-Bit Operation (MODE12 bit = 1):
111 = Signed Fractional 32-bit (DOUT = sddd dddd dddd 0000 0000 0000 0000)
110 = Fractional 32-bit (DOUT = dddd dddd dddd 0000 0000 0000 0000 0000)
101 = Signed Integer 32-bit (DOUT = ssss ssss ssss ssss ssss sddd dddd dddd)
100 = Integer 32-bit (DOUT = 0000 0000 0000 0000 0000 dddd dddd dddd)
011 = Signed Fractional 16-bit (DOUT = 0000 0000 0000 0000 sddd dddd dddd 0000)
010 = Fractional 16-bit (DOUT = 0000 0000 0000 0000 dddd dddd dddd 0000)
001 = Signed Integer 16-bit (DOUT = 0000 0000 0000 0000 ssss sddd dddd dddd)
000 = Integer 16-bit (DOUT = 0000 0000 0000 0000 0000 dddd dddd dddd)
For 10-Bit Operation (MODE12 bit = 0):
111 = Signed Fractional 32-bit (DOUT = sddd dddd dd00 0000 0000 0000 0000)
110 = Fractional 32-bit (DOUT = dddd dddd dd00 0000 0000 0000 0000 0000)
101 = Signed Integer 32-bit (DOUT = ssss ssss ssss ssss ssss sssd dddd dddd)
100 = Integer 32-bit (DOUT = 0000 0000 0000 0000 0000 00dd dddd dddd)
011 = Signed Fractional 16-bit (DOUT = 0000 0000 0000 0000 sddd dddd dd00 0000)
010 = Fractional 16-bit (DOUT = 0000 0000 0000 0000 dddd dddd dd00 0000)
001 = Signed Integer 16-bit (DOUT = 0000 0000 0000 0000 ssss sssd dddd dddd)
000 = Integer 16-bit (DOUT = 0000 0000 0000 0000 0000 00dd dddd dddd)

Note 1: The SAMP bit is cleared and cannot be written if the ADC is disabled (ON bit = 0).
2: The DONE bit is not persistent in Automatic modes; it is cleared by hardware at the beginning of the next sample.

NOTES:

REGISTER 19-2: CMxCON: COMPARATOR x CONTROL REGISTERS (COMPARATORS 1 AND 2)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	R-0, HS, HC	R-0, HS, HC
	ON	COE	CPOL	—	—	—	CEVT	COUT
7:0	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0
	EVPOL<1:0>		—	CREF	—	—	CCH<1:0>	

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **ON:** Comparator Enable bit
- 1 = Comparator is enabled
- 0 = Comparator is disabled

bit 14 **COE:** Comparator Output Enable bit
- 1 = Comparator output is present on the CxOUT pin
- 0 = Comparator output is internal only

bit 13 **CPOL:** Comparator Output Polarity Select bit
- 1 = Comparator output is inverted
- 0 = Comparator output is not inverted

bit 12-10 **Unimplemented:** Read as '0'

bit 9 **CEVT:** Comparator Event bit
- 1 = Comparator event that is defined by EVPOL<1:0> has occurred; subsequent triggers and interrupts are disabled until the bit is cleared
- 0 = Comparator event has not occurred

bit 8 **COUT:** Comparator Output bit

When CPOL = 0:
- 1 = $V_{IN+} > V_{IN-}$
- 0 = $V_{IN+} < V_{IN-}$

When CPOL = 1:
- 1 = $V_{IN+} < V_{IN-}$
- 0 = $V_{IN+} > V_{IN-}$

24.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

24.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

24.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

24.9 PICkit 3 In-Circuit Debugger/ Programmer

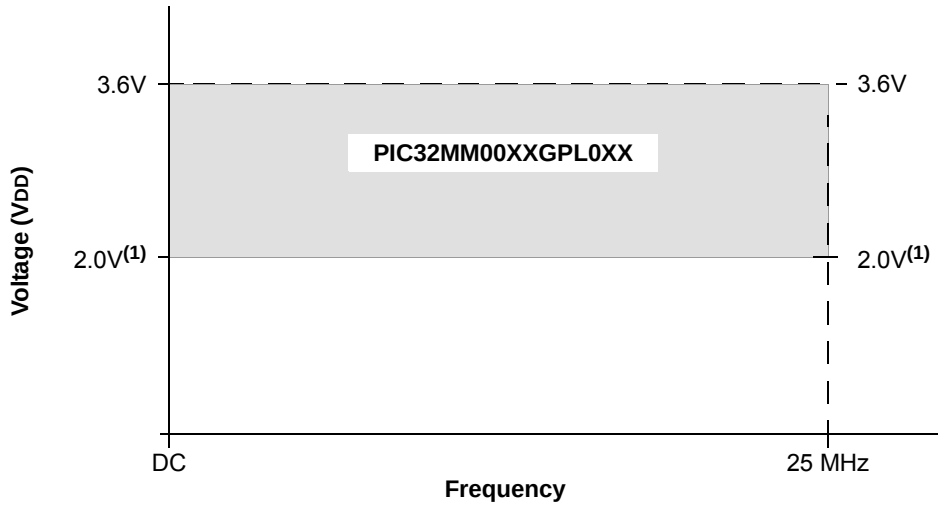
The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

24.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at V_{DDMIN} and V_{DDMAX} for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

26.1 DC Characteristics

FIGURE 26-1: PIC32MM0064GPL036 FAMILY VOLTAGE-FREQUENCY GRAPH



Note 1: Lower operating boundary is 2.0V or VBOR when BOR is enabled.

TABLE 26-1: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min	Typ	Max	Unit
PIC32MM00XXGPL0XX:					
Operating Junction Temperature Range	TJ	-40	—	+105	°C
Operating Ambient Temperature Range	TA	-40	—	+85	°C
Power Dissipation: Internal Chip Power Dissipation: PINT = VDD x (IDD – Σ IOH) I/O Pin Power Dissipation: PI/O = Σ ({VDD – VOH} x IOH) + Σ (VOL x IOL)	PD	PINT + PI/O			W
Maximum Allowed Power Dissipation	PDMAX	(TJ – TA)/θJA			W

TABLE 26-2: PACKAGE THERMAL RESISTANCE(1)

Package	Symbol	Typ	Unit
20-Pin SSOP	θJA	87.3	°C/W
20-Pin QFN	θJA	43.0	°C/W
28-Pin SPDIP	θJA	60.0	°C/W
28-Pin SSOP	θJA	71.0	°C/W
28-Pin SOIC	θJA	69.7	°C/W
28-Pin UQFN	θJA	27.5	°C/W
28-Pin QFN	θJA	20.0	°C/W
36-Pin VQFN	θJA	31.1	°C/W
40-Pin UQFN	θJA	41.0	°C/W

Note 1: Junction to ambient thermal resistance; Theta-JA (θJA) numbers are achieved by package simulations.

TABLE 26-9: I/O PIN INPUT INJECTION CURRENT SPECIFICATIONS

Operating Conditions: 2.0V ≤ VDD ≤ 3.6V, -40°C ≤ TA ≤ +85°C (unless otherwise stated)						
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Max.**	**Units**	**Conditions**
DI60a	IICL	**Input Low Injection Current**	0	-5**(1,4)**	mA	This parameter applies to all pins.
DI60b	IICH	**Input High Injection Current**	0	+5**(2,3,4)**	mA	This parameter applies to all pins, with the exception of all 5V tolerant pins and SOSCI. Maximum IICH current for these exceptions is 0 mA.
DI60c	∑IICT	**Total Input Injection Current (sum of all I/O and control pins)**	-20**(5)**	+20**(5)**	mA	Absolute instantaneous sum of all ± input injection currents from all I/O pins, (| IICL + | IICH |) ≤ ∑IICT

Note 1: VIL Source < (VSS – 0.3). Characterized but not tested.

2: VIH Source > (VDD + 0.3) for non-5V tolerant pins only.

3: Digital 5V tolerant pins do not have an internal high-side diode to VDD, and therefore, cannot tolerate any "positive" input injection current.

4: Injection currents can affect the ADC results.

5: Any number and/or combination of I/O pins, not excluded under IICL or IICH conditions, are permitted provided the "absolute instantaneous" sum of the input injection currents from all pins do not exceed the specified limit.

TABLE 26-22: RESET, BROWN-OUT RESET AND SLEEP MODES TIMING SPECIFICATIONS

Operating Conditions: 2.0V ≤ VDD ≤ 3.6V, -40°C ≤ TA ≤ +85°C (unless otherwise stated)							
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(1)**	**Max**	**Units**	**Conditions**
SY10	TMCL	$\overline{\text{MCLR}}$ Pulse Width (Low)	2	—	—	µs	
SY13	TIOZ	I/O High-Impedance from $\overline{\text{MCLR}}$ Low	—	1	—	µs	
SY25	TBOR	Brown-out Reset Pulse Width	1	—	—	µs	VDD ≤ VBOR
SY45	TRST	Reset State Time	—	25	—	µs	
SY71	TWAKE(2)	Wake-up Time with Main Voltage Regulator	—	22	—	µs	Sleep wake-up with VREGS = 0, RETEN = 0, RETVR = 1
			—	3.8	—	µs	Sleep wake-up with VREGS = 1, RETEN = 0, RETVR = 1
SY72	TWAKELVR(2)	Wake-up Time with Retention Low-Voltage Regulator	—	163	—	µs	Sleep wake-up with VREGS = 0, RETEN = 1, RETVR = 0
			—	23	—	µs	Sleep wake-up with VREGS = 1, RETEN = 1, RETVR = 0

Note 1: Data in the “Typ.” column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The parameters are measured with the external clock source (EC). To get the full wake-up time, the oscillator start-up time must be added.

FIGURE 26-14: EJTAG TIMING CHARACTERISTICS

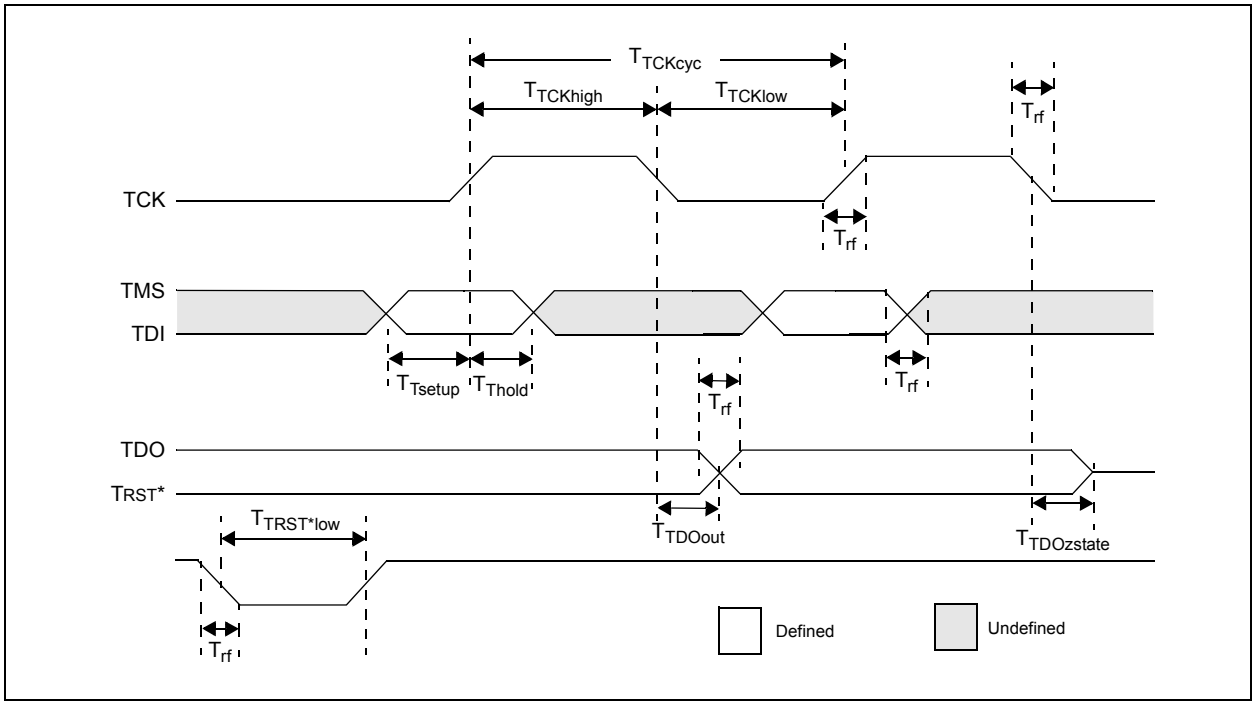


TABLE 26-33: EJTAG TIMING REQUIREMENTS

Operating Conditions: 2.0V ≤ VDD ≤ 3.6V, -40°C ≤ TA ≤ +85°C (unless otherwise stated)						
Param. No.	**Symbol**	**Description(1)**	**Min**	**Max**	**Units**	**Conditions**
EJ1	TTCKCYC	TCK Cycle Time	25	—	ns	
EJ2	TTCKHIGH	TCK High Time	10	—	ns	
EJ3	TTCKLOW	TCK Low Time	10	—	ns	
EJ4	TTSETUP	TAP Signals Setup Time before Rising TCK	5	—	ns	
EJ5	TTHOLD	TAP Signals Hold Time after Rising TCK	3	—	ns	
EJ6	TTDOOUT	TDO Output Delay Time from Falling TCK	—	5	ns	
EJ7	TTDOZSTATE	TDO 3-State Delay Time from Falling TCK	—	5	ns	
EJ8	TTRSTLOW	TRST Low Time	25	—	ns	
EJ9	TRF	TAP Signals Rise/Fall Time, All Input and Output	—	—	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

NOTES: